

# D5FY10ST

## Schottky Barrier Diodes

100V, 5A

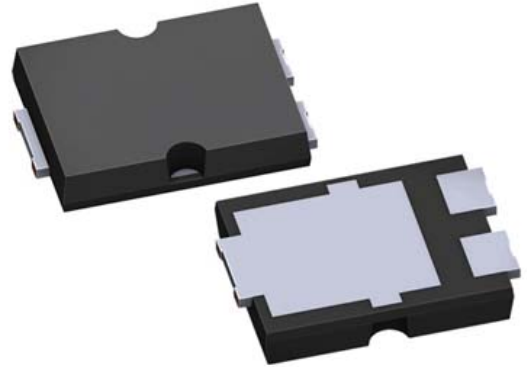
### Feature

- Permit high current with a small package
- $T_j=175^{\circ}\text{C}$
- Ultra low  $I_R$
- Based on AEC-Q101
- Halogen free
- Pb free terminal
- RoHS:Yes

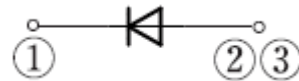
### OUTLINE

Package (House Name): FY

Package (JEDEC Code): TO-277A similar



### Equivalent circuit



### Absolute Maximum Ratings (unless otherwise specified : $T_I=25^{\circ}\text{C}$ )

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	$T_{stg}$		-55 to 175	$^{\circ}\text{C}$
Junction temperature	$T_j$		-55 to 175	$^{\circ}\text{C}$
Repetitive peak reverse voltage	$V_{RRM}$		100	V
Average forward current	$I_F(AV)$	50Hz sine wave, Resistance load, With heatsink, $T_I=162^{\circ}\text{C}$ *	5	A
Average forward current	$I_F(AV)$	50Hz sine wave, Resistance load, On alumina substrate, $T_a=25^{\circ}\text{C}$ *	3.4	A
Average forward current	$I_F(AV)$	50Hz sine wave, Resistance load, On glass-epoxy substrate, $T_a=25^{\circ}\text{C}$ *	3.1	A
Surge forward current	$I_{FSM}$	50Hz sine wave, Non-repetitive, 1 cycle, Peak value, $T_j=25^{\circ}\text{C}$	210	A

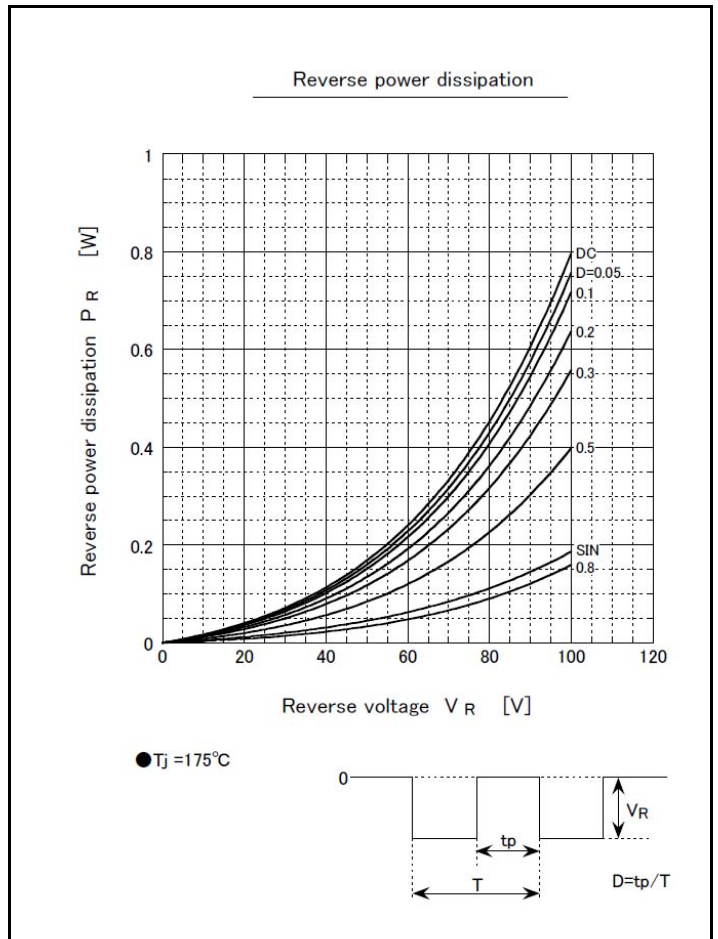
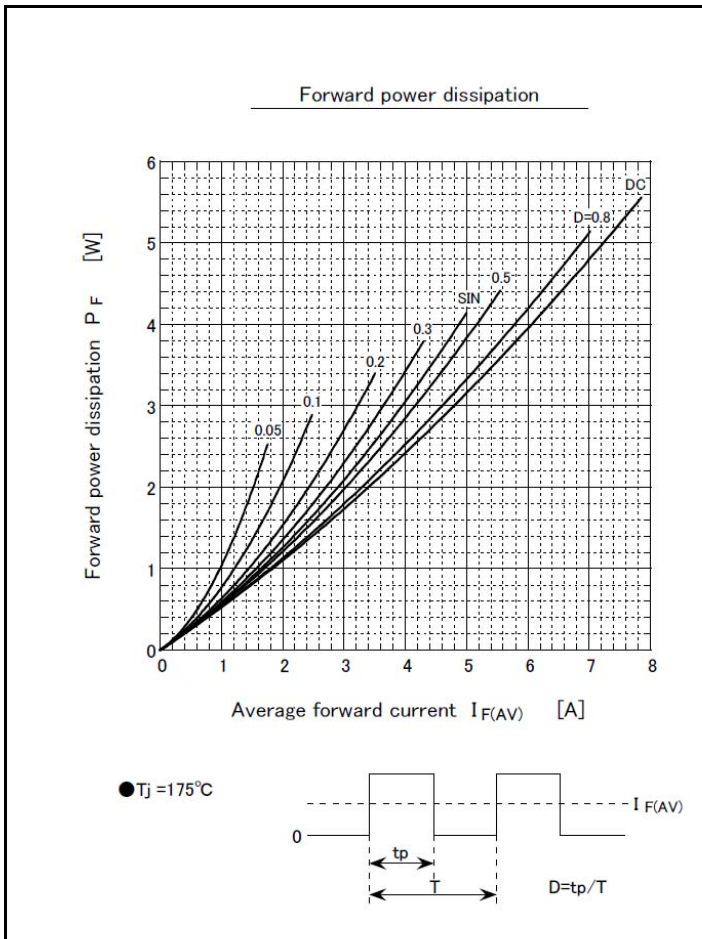
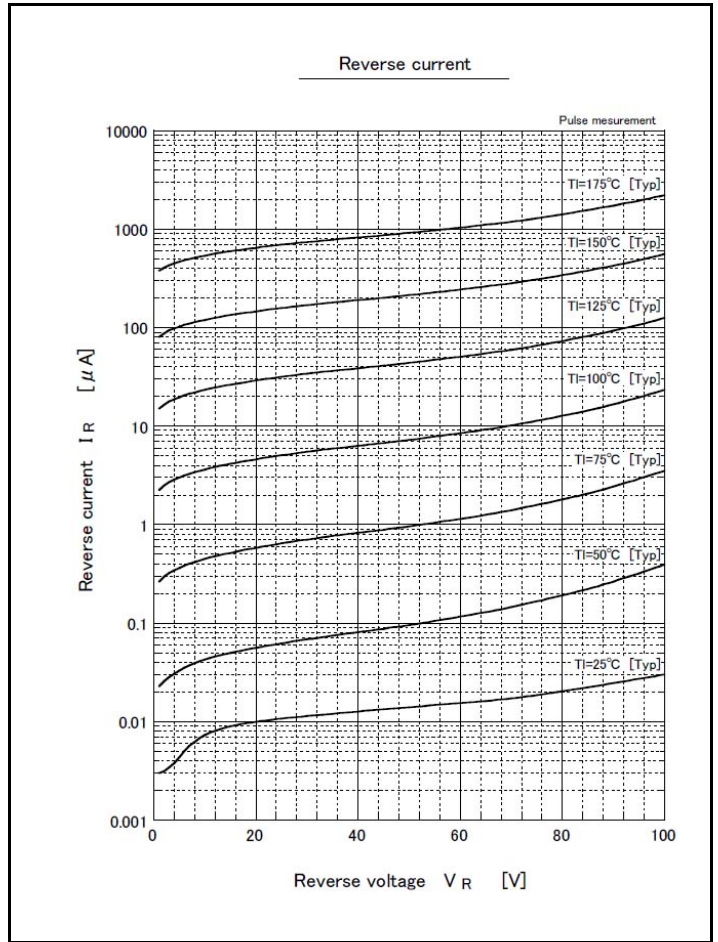
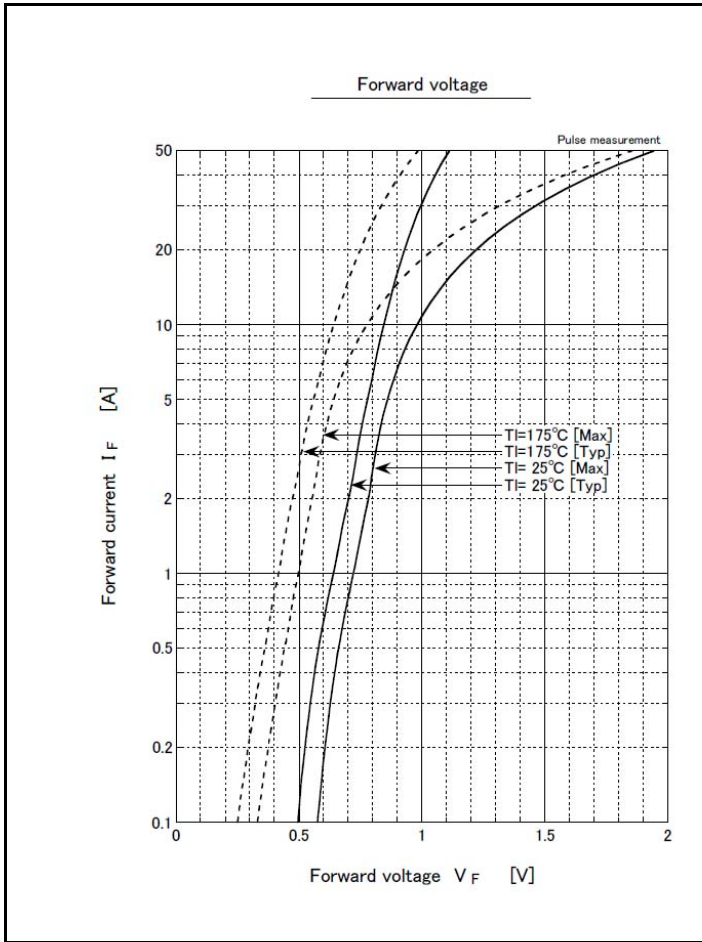
\* : See the original Specifications

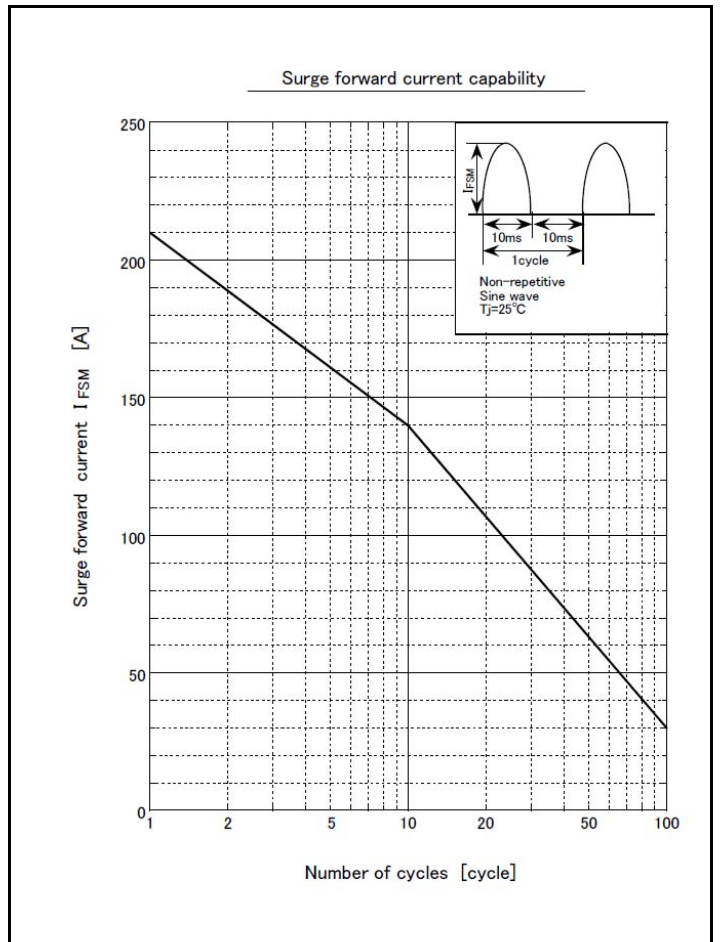
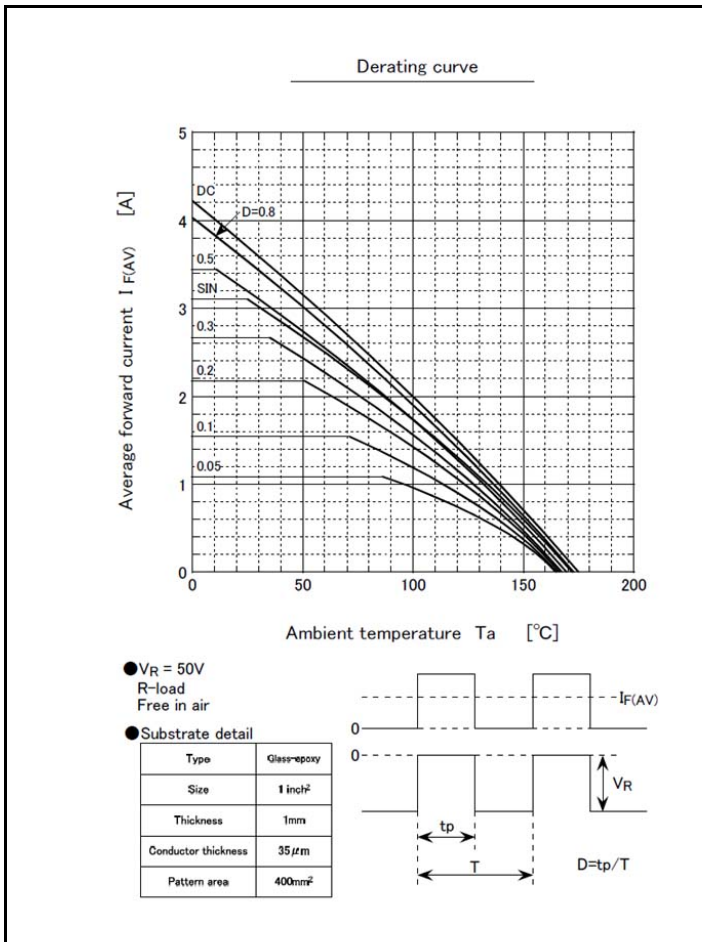
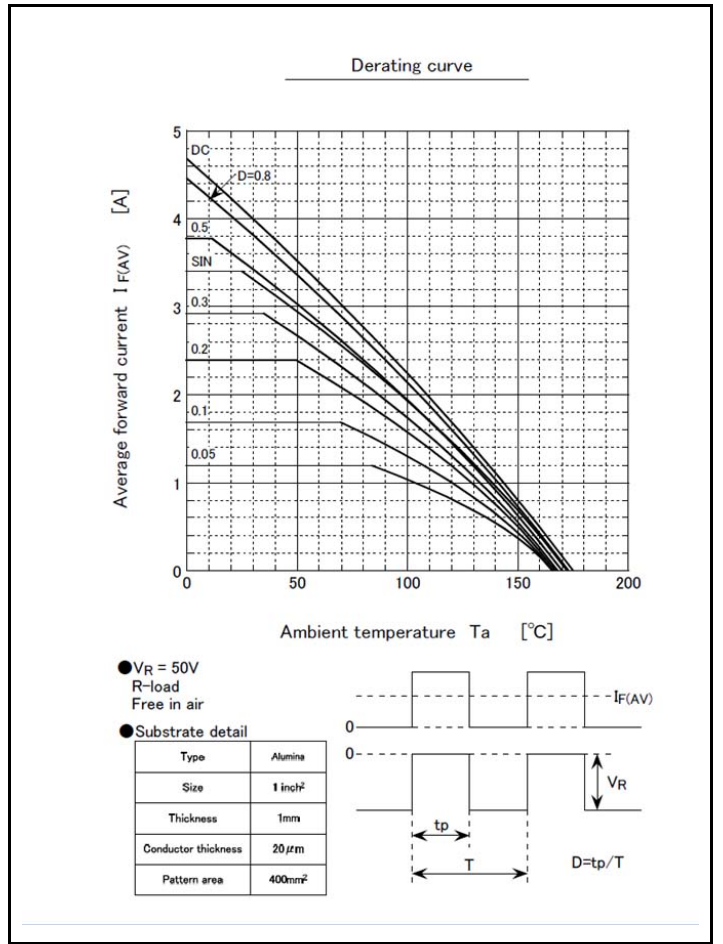
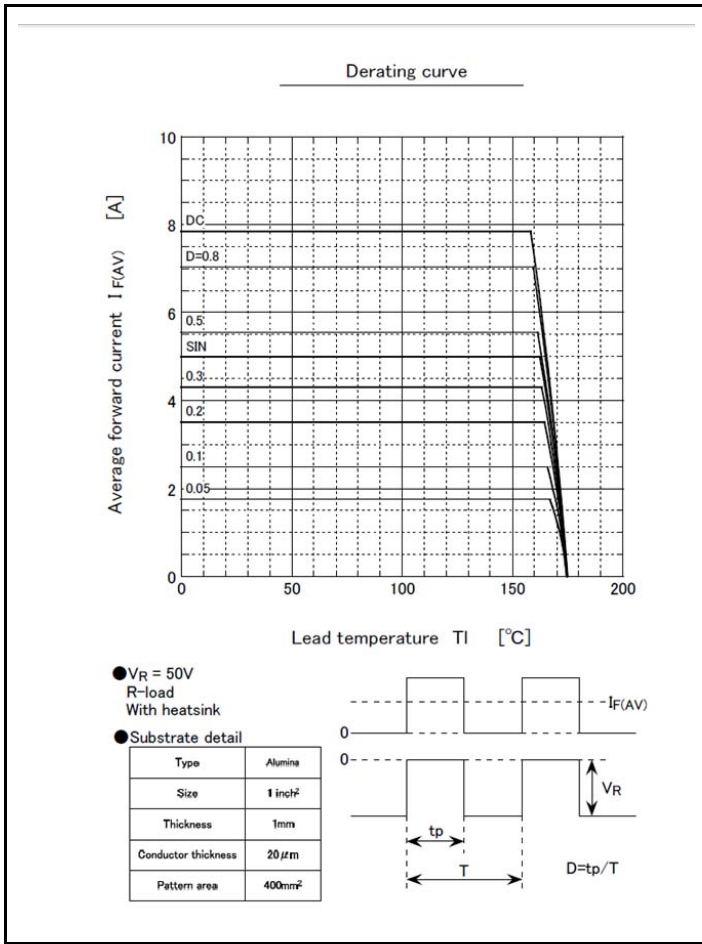
**Electrical Characteristics** (unless otherwise specified : Tl=25°C)

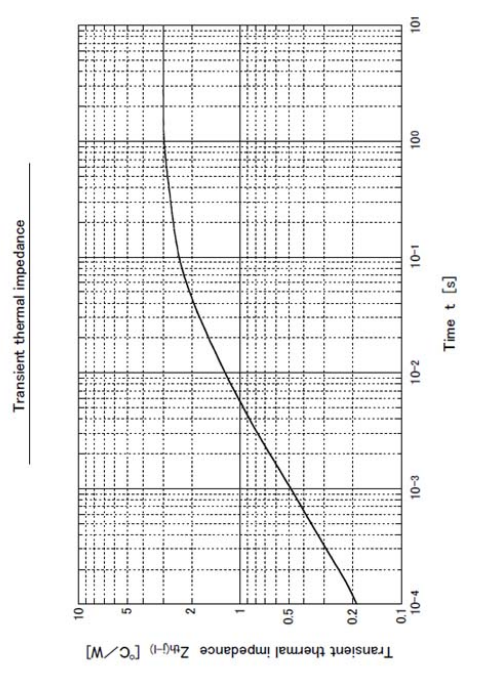
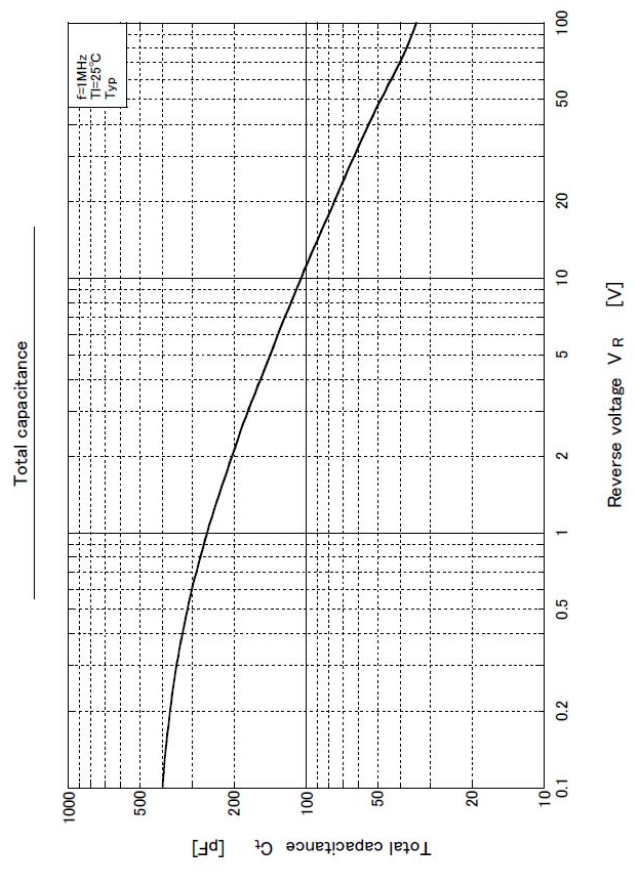
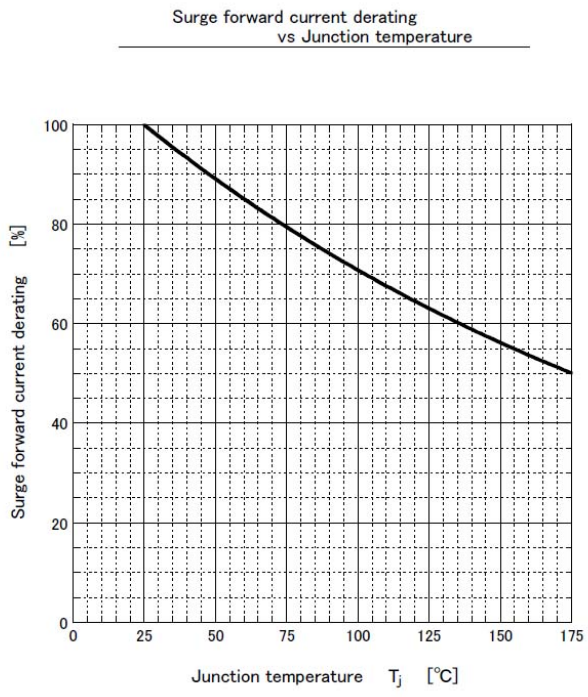
Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Forward voltage	$V_F$	$I_F=5A$ , Pulse measurement			0.86	V
Reverse current	$I_R$	$V_R=100V$ , Pulse measurement			0.015	mA
Total capacitance	$C_t$	$f=1MHz$ , $V_R=10V$		104		pF
Thermal resistance	$R_{th(j-l)}$	Junction to lead, With heatsink *			3	°C/W
Thermal resistance	$R_{th(j-a)}$	Junction to ambient, On alumina substrate *			60	°C/W
Thermal resistance	$R_{th(j-a)}$	Junction to ambient, On glass-epoxy substrate *			65	°C/W

\* :See the original Specifications

# CHARACTERISTIC DIAGRAMS



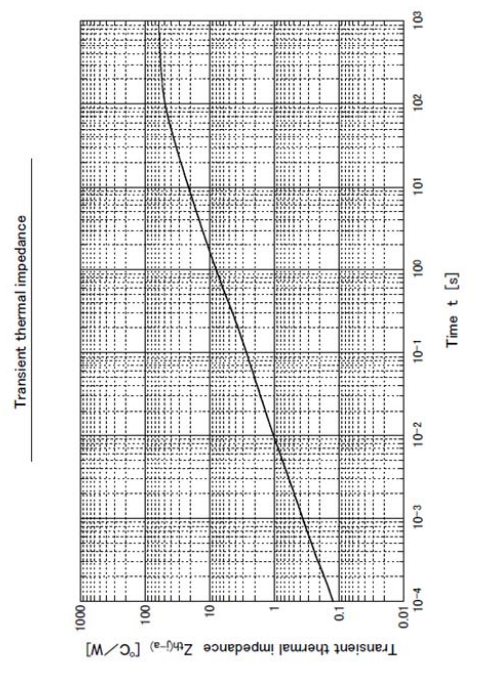




● Substrate detail

Type	Alumina
Size	1 inch <sup>2</sup>
Thickness	1mm
Conductor thickness	20μm
Pattern area	400mm <sup>2</sup>

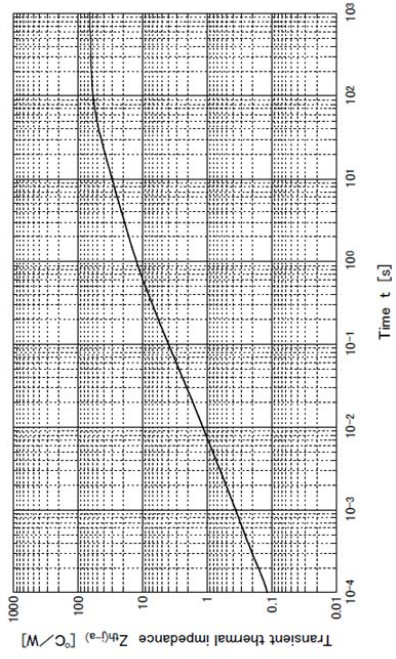
● TI sensing point



● Substrate detail

Type	Alumina
Size	1 inch <sup>2</sup>
Thickness	1mm
Conductor thickness	20μm
Pattern area	400mm <sup>2</sup>

Transient thermal impedance

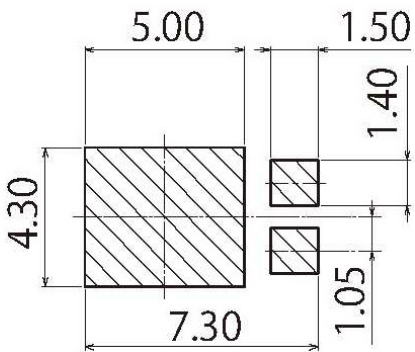
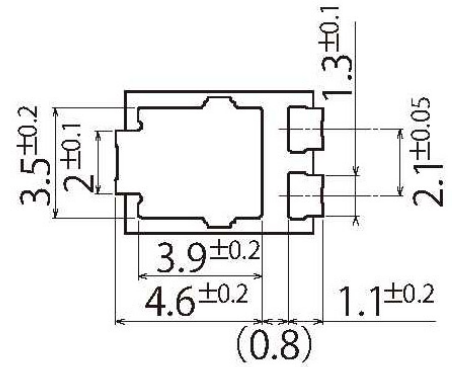
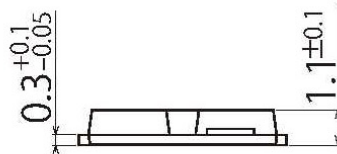
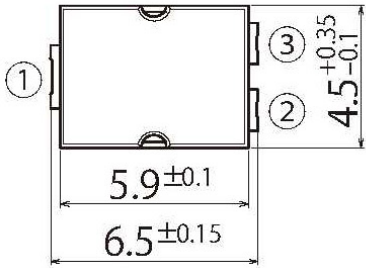


● Substrate detail

Type	Glass-epoxy
Size	1 inch <sup>2</sup>
Thickness	1mm
Conductor thickness	35μm
Pattern area	400mm <sup>2</sup>

G4

JEDEC Code	TO-277A similar
JEITA Code	-
House Name	FY



Referential Soldering Pad

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